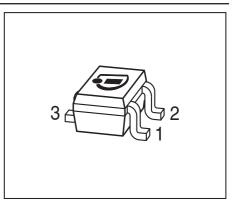


BFR93AW

NPN Silicon RF Transistor

- For low distortion amplifiers and oscillators up to 2 GHz at collector currents from 5 mA to 30 mA
- Pb-free (RoHS compliant) package
- Qualification report according to AEC-Q101 available





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking		Pin Conf	iguration	Package	
BFR93AW	R2s	1=B	2=E	3=C	SOT323	
Maximum Ratings at $T_A = 25$	5 °C, unless	otherwi	ise specified	ł		
Parameter		Symbol	Value	Unit		
Collector-emitter voltage			V _{CEO}	12	V	
Collector-emitter voltage	llector-emitter voltage		V _{CES}	20		
Collector-base voltage	 ctor-base voltage		V _{CBO}	20		
Emitter-base voltage			V _{EBO}	2		
Collector current			I _C	90	mA	
Base current			I _B	9		
otal power dissipation ¹⁾		P _{tot}	300	mW		
<i>T</i> _S ≤ 104 °C						
unction temperature		T _J 150		°C		
Ambient temperature			T _A	-65 15	0	
Storage temperature			T _{Stg}	-65 15	50	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ²⁾	R _{thJS}	155	K/W

 ${}^{1}\mathcal{T}_{S}$ is measured on the collector lead at the soldering point to the pcb

²For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)



Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage	V _{(BR)CEO}	12	-	-	V
I _C = 1 mA, I _B = 0					
Collector-emitter cutoff current	I _{CES}	-	-	100	μA
V _{CE} = 20 V, V _{BE} = 0					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\rm CB} = 10 \text{ V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I _{EBO}	-	-	10	μA
$V_{\rm EB} = 2 \text{ V}, I_{\rm C} = 0$					
DC current gain	h _{FE}	70	100	140	-
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, pulse measured					

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified



Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling)					
Transition frequency	f _T	4.5	6	-	GHz
<i>I</i> _C = 30 mA, <i>V</i> _{CE} = 8 V, <i>f</i> = 500 MHz					
Collector-base capacitance	C _{cb}	-	0.58	0.8	pF
$V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
emitter grounded					
Collector emitter capacitance	C _{ce}	-	0.3	-	
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
base grounded					
Emitter-base capacitance	C _{eb}	-	1.9	-	
$V_{\rm EB}$ = 0.5 V, <i>f</i> = 1 MHz, $V_{\rm CB}$ = 0 ,					
collector grounded					
Minimum noise figure	NF _{min}				dB
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,					
<i>f</i> = 900 MHz		-	1.5	-	
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,					
<i>f</i> = 1.8 GHz		-	2.6	-	
Power gain, maximum available ¹⁾	G _{ma}				
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$,					
<i>f</i> = 900 MHz		-	15.5	-	
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$,					
<i>f</i> = 1.8 GHz		-	10.5	-	
Transducer gain	S _{21e} ²				dB
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
<i>f</i> = 900 MHz		-	13	-	
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
<i>f</i> = 1.8 MHz		-	7.5	-	

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified

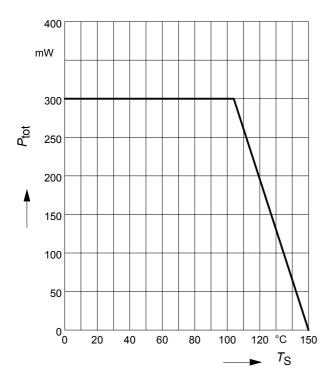
 ${}^{1}G_{\text{ma}} = |S_{21e} / S_{12e}| (k - (k^{2} - 1)^{1/2})$



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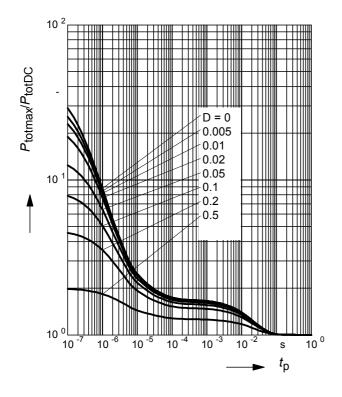
Total power dissipation $P_{tot} = f(T_S)$

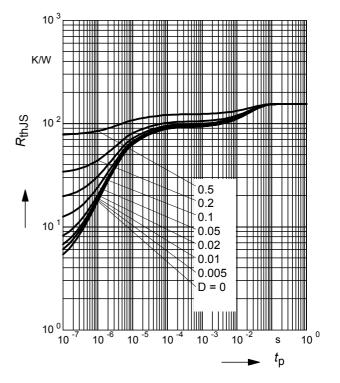
Permissible Pulse Load $R_{\text{thJS}} = f(t_p)$



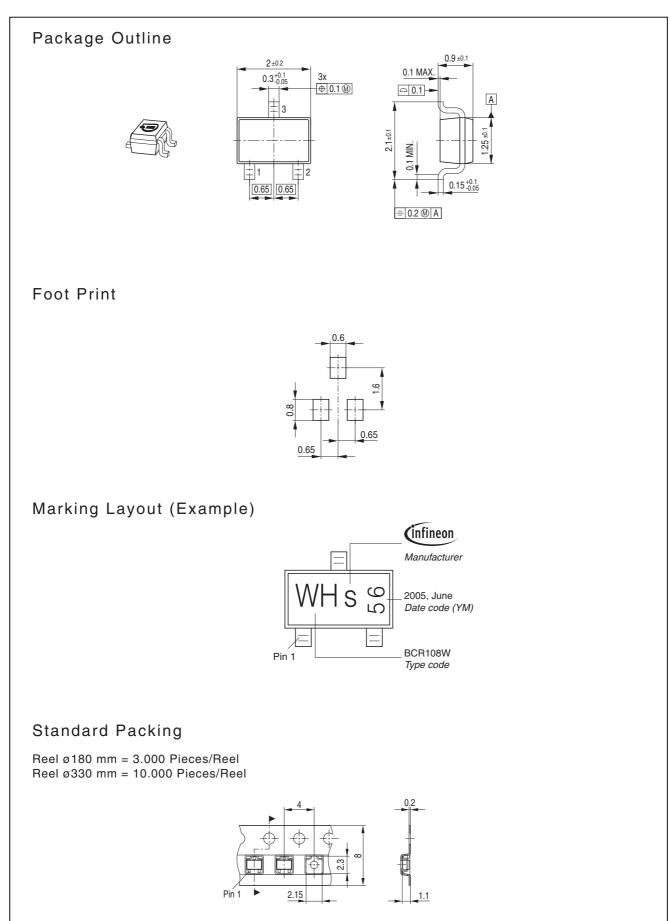
Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{p})$











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